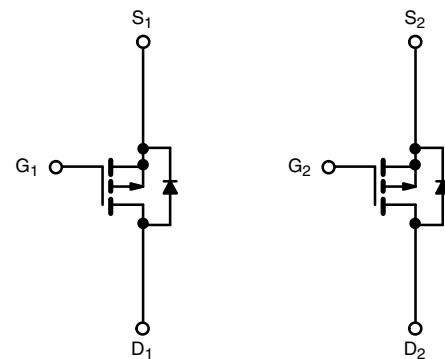
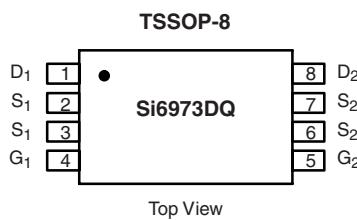


Dual P-Channel 1.8-V (G-S) MOSFET

| PRODUCT SUMMARY | | |
|-----------------|-----------------------------|-----------|
| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) |
| - 20 | 0.030 at $V_{GS} = - 4.5$ V | - 4.8 |
| | 0.039 at $V_{GS} = - 2.5$ V | - 4.2 |
| | 0.055 at $V_{GS} = - 1.8$ V | - 3.5 |

FEATURES

- Halogen-free
- TrenchFET® Power MOSFETs: 1.8 V Rated


RoHS
COMPLIANT


Ordering Information: Si6973DQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted | | | | | |
|--|----------------|---------------|--------------|-------|---|
| Parameter | Symbol | 10 s | Steady State | Unit | |
| Drain-Source Voltage | V_{DS} | | - 20 | | V |
| Gate-Source Voltage | V_{GS} | | ± 8 | | |
| Continuous Drain Current ($T_J = 150$ °C) ^a | I_D | $T_A = 25$ °C | - 4.8 | - 4.1 | A |
| | | $T_A = 70$ °C | - 3.9 | - 3.2 | |
| Pulsed Drain Current (10 μ s Pulse Width) | I_{DM} | | - 30 | | |
| Continuous Source Current (Diode Conduction) ^a | I_S | | - 1.0 | - 0.7 | |
| Maximum Power Dissipation ^a | P_D | $T_A = 25$ °C | 1.14 | 0.83 | W |
| | | $T_A = 70$ °C | 0.73 | 0.53 | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to 150 | | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|------------|---------|---------|------|--|
| Parameter | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^a | R_{thJA} | 86 | 110 | °C/W | |
| | | 124 | 150 | | |
| Maximum Junction-to-Foot (Drain) | R_{thJF} | 52 | 65 | | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

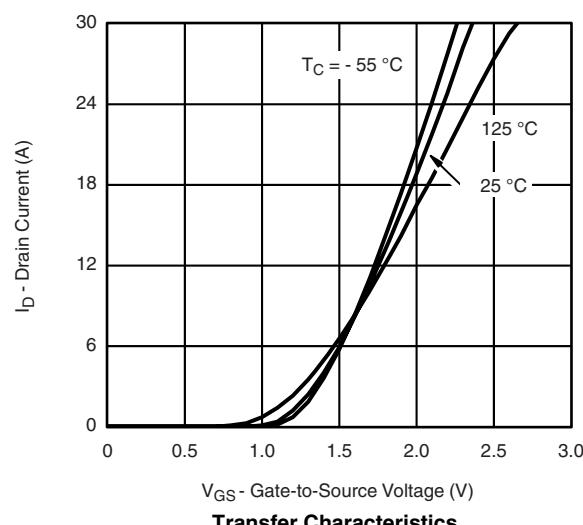
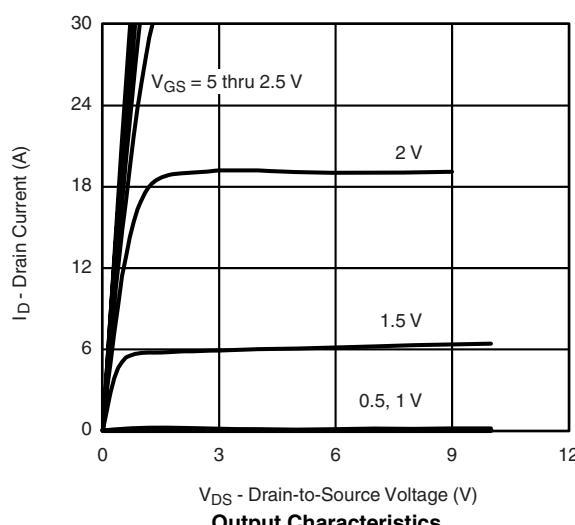
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---------------------|---|--|--------|-----------|---------------|
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}$, $I_D = -250\ \mu\text{A}$ | - 0.45 | | | V |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 8\ \text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = -16\ \text{V}$, $V_{GS} = 0\ \text{V}$ | | - 1 | | μA |
| | | $V_{DS} = -16\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 70^\circ\text{C}$ | | - 25 | | |
| On-State Drain Current ^a | $I_{D(\text{on})}$ | $V_{DS} = -5\ \text{V}$, $V_{GS} = -4.5\ \text{V}$ | - 20 | | | A |
| Drain-Source On-State Resistance ^a | $R_{DS(\text{on})}$ | $V_{GS} = -4.5\ \text{V}$, $I_D = -4.8\ \text{A}$ | | 0.025 | 0.030 | Ω |
| | | $V_{GS} = -2.5\ \text{V}$, $I_D = -4.2\ \text{A}$ | | 0.033 | 0.039 | |
| | | $V_{GS} = -1.8\ \text{V}$, $I_D = -3.5\ \text{A}$ | | 0.046 | 0.055 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = -5\ \text{V}$, $I_D = -4.8\ \text{A}$ | | 21 | | S |
| Diode Forward Voltage ^a | V_{SD} | $I_S = -1.0\ \text{A}$, $V_{GS} = 0\ \text{V}$ | | - 0.65 | - 1.1 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = -10\ \text{V}$, $V_{GS} = -4.5\ \text{V}$, $I_D = -4.8\ \text{A}$ | | 21 | 30 | nC |
| Gate-Source Charge | Q_{gs} | | | 4.4 | | |
| Gate-Drain Charge | Q_{gd} | | | 3.3 | | |
| Turn-On Delay Time | $t_{d(\text{on})}$ | $V_{DD} = -10\ \text{V}$, $R_L = 10\ \Omega$ $I_D \equiv -1\ \text{A}$, $V_{GEN} = -4.5\ \text{V}$, $R_G = 6\ \Omega$ | | 27 | 40 | ns |
| Rise Time | t_r | | | 27 | 40 | |
| Turn-Off Delay Time | $t_{d(\text{off})}$ | | | 93 | 140 | |
| Fall Time | t_f | | | 43 | 65 | |
| Source-Drain Reverse Recovery Time | t_{rr} | | $I_F = -1.0\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$ | 30 | 50 | |

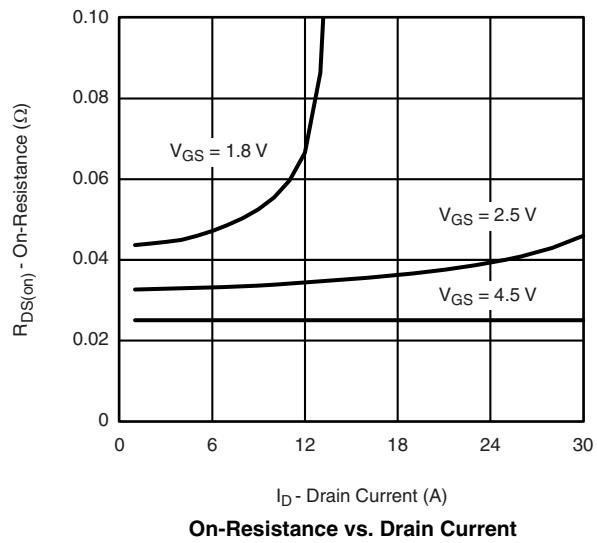
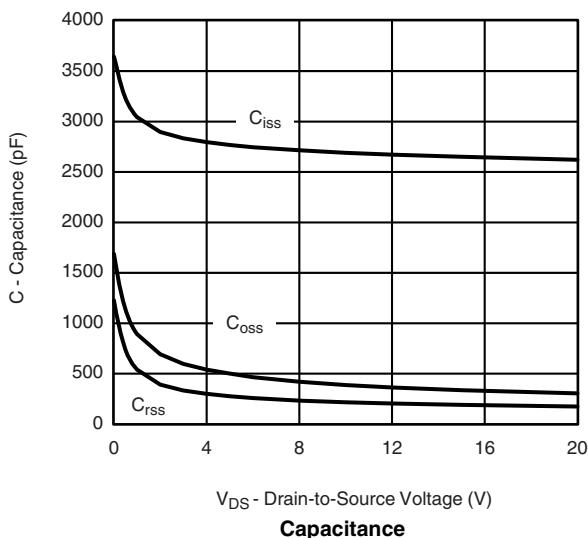
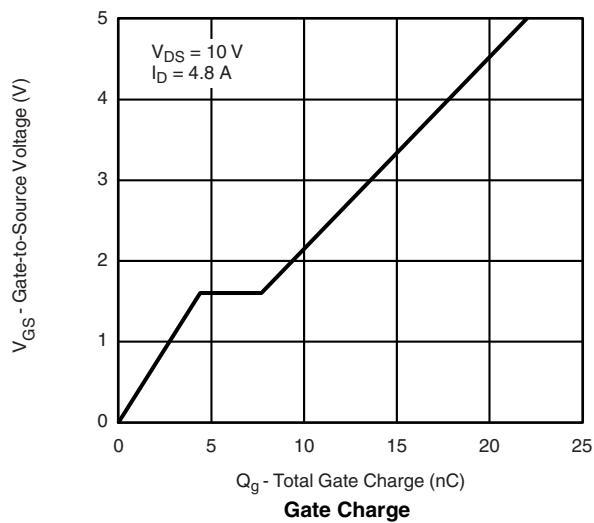
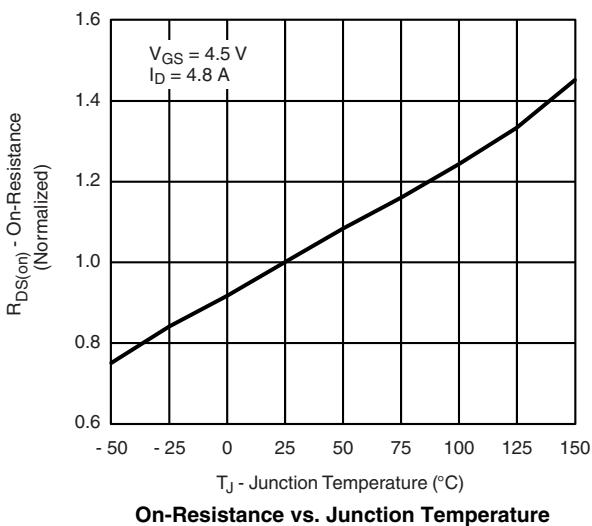
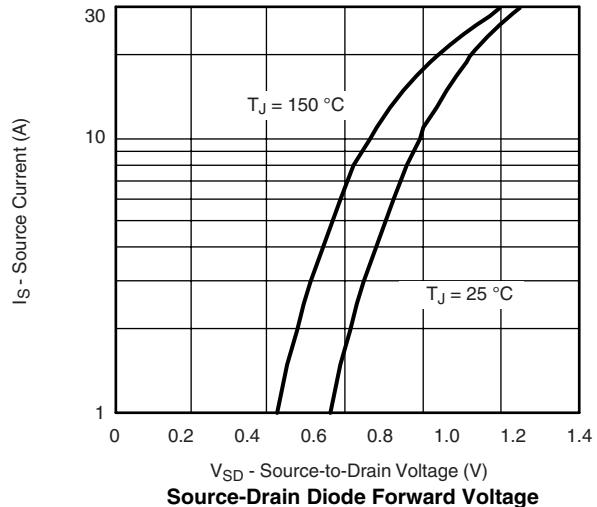
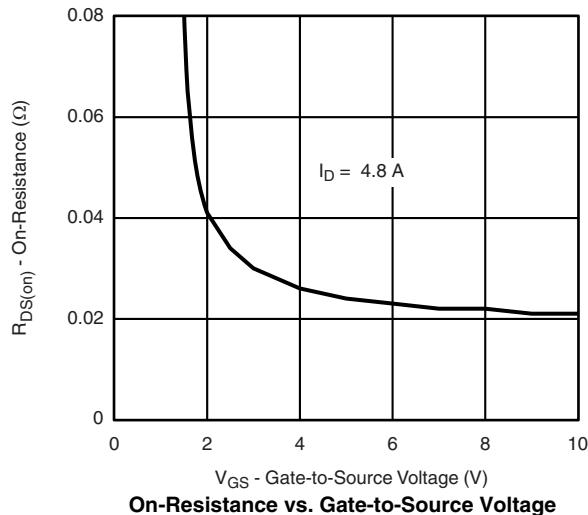
Notes:

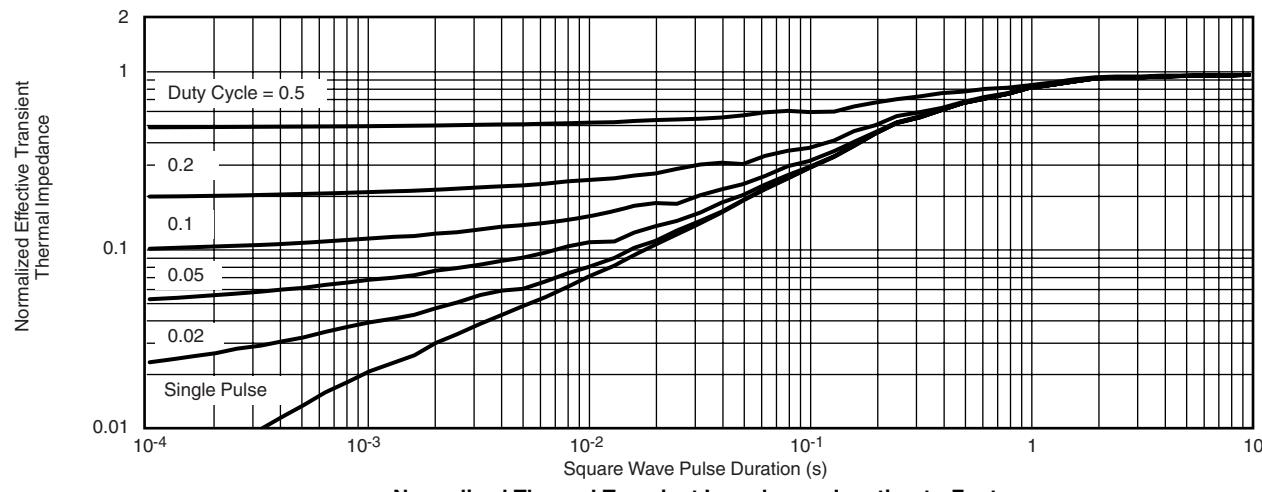
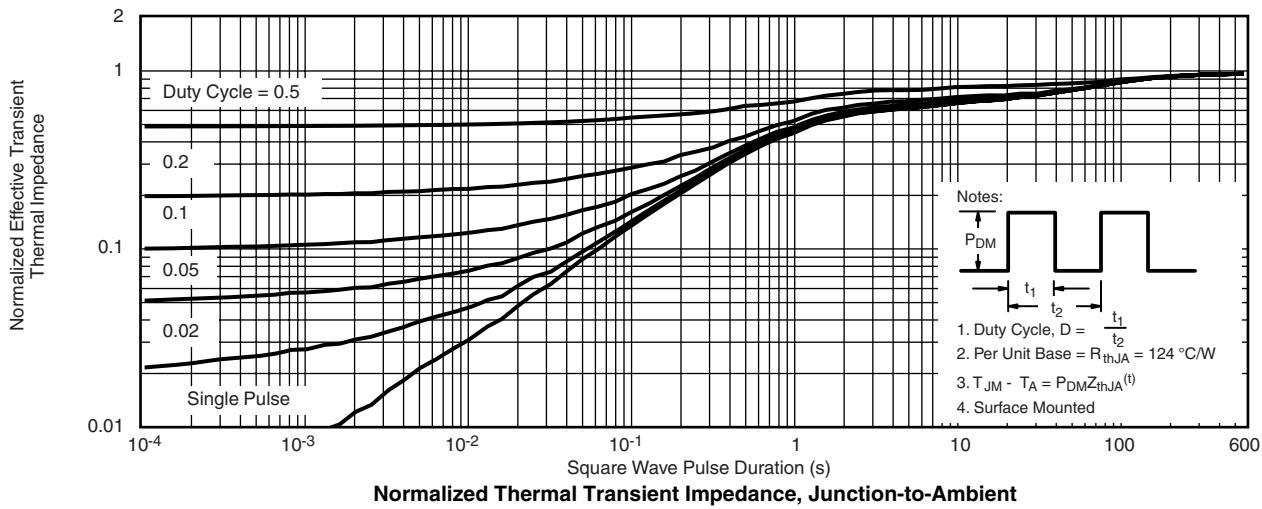
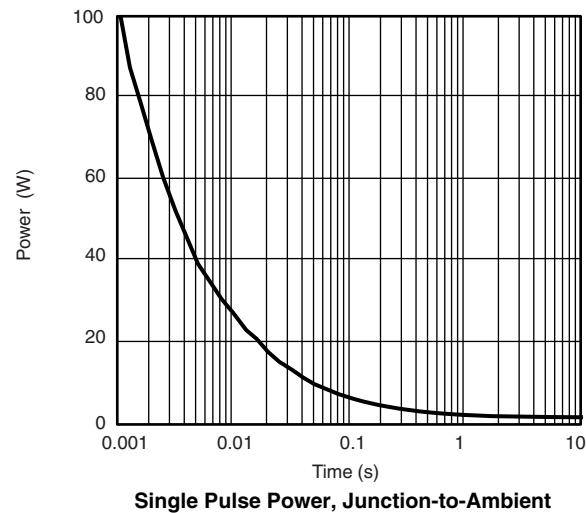
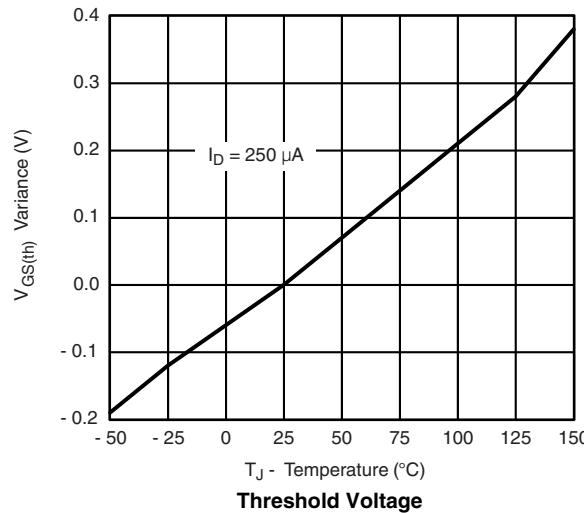
a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\ %$.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25°C , unless otherwise noted


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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